

ICTMP 2026

Sponsorship Packages

 ICTMP
2026

The International Conference on Tribology in Manufacturing Processes (ICTMP) & Advanced Surface Engineering is a prestigious event that brings together experts, researchers, and industry leaders from around the world to share their knowledge and advancements in tribology and surface engineering. This conference will explore the latest research, methodologies, and technologies, making it an ideal platform for networking and collaboration.

The ICTMP conference will take place from July 22 to 24, 2026, at the Arnoma Grand Bangkok. It is organized by the International Research Group of Tribology in Manufacturing (IRGTM) in collaboration with the Thai Tribology Association (TTA), the National Metal and Materials Technology Center (MTEC), King Mongkut's University of Technology North Bangkok (KMUTNB), and King Mongkut's University of Technology Thonburi (KMUTT). This conference will focus on the latest research, methodologies, and technologies in the field, making it an excellent platform for networking and collaboration.

We invite you to become a sponsor of the ICTMP 2026. Your sponsorship will provide significant visibility and participation in this influential event. We offer a range of sponsorship packages designed to suit different levels of support:



Benefits	Diamond Sponsor	Platinum Sponsor	Gold Sponsor
Amount (THB, VAT 7% included)	200,000	100,000	50,000
Free registration (number of participants)	5	3	1
Exhibition area (width x length)	2 m x 6 m	2 m x 3 m	No
Exhibition rollup	Yes	Yes	Yes
Advertisement in the conference proceedings	2 Full Page	1 Full Page	Half Page
Company logo in the conference proceedings	Yes	Yes	Yes
Company logo and link on the conference website	Yes	Yes	Yes
Prominent signage throughout the conference venue	Yes	Yes	Yes
Recognition during the River Cruise dinner	Yes	Yes	Yes

Why You Should Sponsor:

Visibility: Gain exposure to industry leaders, researchers, and professionals in the field of tribology and manufacturing.

Networking: Connect with potential clients, collaborators, and influencers in tribology and surface engineering.

Support Innovation: Contribute to the advancement of research and technology in a key area of manufacturing.

For questions concerning the sponsorship packages, please contact

Numpon Mahayotsanun

Department of Mechanical and Aerospace Engineering, Faculty of Engineering, King Mongkut's University of Technology North Bangkok (KMUTNB)

518 Pracharat 1 Road, Wongsawang, Bangsue, Bangkok 10800 THAILAND

+66 89 714 6665

numpon.m@eng.kmutnb.ac.th

ICTMP 2026

Sponsorship Packages Application Form

Please complete the application form and send the payment confirmation to the ICTMP 2026 Co-Chair (Numpon Mahayotsanun) by Email to numpon.m@eng.kmutnb.ac.th



First Name	
Last Name	
Company Name	
Company Tax ID	
Position	
Postal Address	
Mobile	
Email	
Signature	
Date	
Sponsorship Package Selection Amount (THB, VAT 7% Included)	

Payment Details: All prices are inclusive of 7% VAT.

Payment Method: Bank transfer to the savings account

Bank Name: BANGKOK BANK PLC.

Swift Code: BKKBTHBK

Account Name: Thai Tribology Association (สมาคมการลื่นหรือและการหล่อลื่นไทย)

Account Number: 080-0-11272-4

For cancellation, the following applies:

- Two months or more before conference – 50% refund
- Less than two months before the conference – no refund



CONTACT
WEBSITE: WWW.MTEC.OR.TH/ICTMP2026
EMAIL: ICTMP2026@MTEC.OR.TH